SIEMENS

Data sheet

6ES7317-6FF04-0AB0



SIMATIC S7-300, CPU 317F-2DP, Central processing unit with 1.5 MB work memory, 1st interface MPI/DP 12 Mbit/s, 2nd interface DP master/slave Micro Memory Card required Can be used with software package S7 Distributed Safety V5.2 SP1 or higher

General information	
HW functional status	01
Firmware version	V3.3
Engineering with	
Programming package	STEP 7 V5.5 + SP1 or higher or STEP 7 V5.2 + SP1 or higher with HSP 202 + Distributed Safety
Supply voltage	
Rated value (DC)	24 V
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
external protection for power supply lines (recommendation)	2 A min.
Input current	
Current consumption (rated value)	870 mA
Current consumption (in no-load operation), typ.	120 mA
Inrush current, typ.	4 A
l²t	1 A ² ·s
Power loss	
Power loss, typ.	4.5 W
Memory	
Work memory	
• integrated	1 536 kbyte
expandable	No
Load memory	
Plug-in (MMC)	Yes
Plug-in (MMC), max.	8 Mbyte
 Data management on MMC (after last programming), min. 	10 y
Backup	
present	Yes; Guaranteed by MMC (maintenance-free)
without battery	Yes; Program and data
CPU processing times	
for bit operations, typ.	0.025 µs
for word operations, typ.	0.03 µs
for fixed point arithmetic, typ.	0.04 μs
for floating point arithmetic, typ.	0.16 µs
CPU-blocks	
Number of blocks (total)	2 048; (DBs, FCs, FBs); the maximum number of loadable blocks can be reduced by the MMC used.
DB	

Number, max.	2 048; Number range: 1 to 16000
• Size, max.	64 kbyte
FB	o i nujio
Number, max.	2 048; Number range: 0 to 7999
• Size, max.	64 kbyte
FC	OH ROYE
Number, max.	2 048; Number range: 0 to 7999
• Size, max.	64 kbyte
OB	
Number, max.	see instruction list
• Size, max.	64 kbyte
Number of free cycle OBs	1; OB 1
Number of time alarm OBs	1; OB 10
Number of delay alarm OBs	2; OB 20, 21
Number of cyclic interrupt OBs	4; OB 32, 33, 34, 35
Number of process alarm OBs	1; OB 40
Number of DPV1 alarm OBs	3; OB 55, 56, 57
 Number of isochronous mode OBs 	1; OB 61
Number of startup OBs	1; OB 100
Number of asynchronous error OBs	5; OB 80, 82, 85, 86, 87
Number of synchronous error OBs	2; OB 121, 122
Nesting depth	
per priority class	16
additional within an error OB	4
Counters, timers and their retentivity	
S7 counter	
Number	512
Retentivity	
— adjustable	Yes
— lower limit	0
— upper limit	511
— preset	Z 0 to Z 7
Counting range	
— lower limit	0
— upper limit	999
IEC counter	
• present	Yes
• Type	SFB
Number	Unlimited (limited only by RAM capacity)
S7 times	
Number	512
Retentivity	
— adjustable	Yes
— lower limit	0
— upper limit	511
— preset	No retentivity
Time range	
— lower limit	10 ms
— upper limit	9 990 s
IEC timer	
• present	Yes
• Type	SFB
Number	Unlimited (limited only by RAM capacity)
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	256 kbyte
Flag	
• Size, max.	4 096 byte
B (0) 3 11	Yes; From MB 0 to MB 4 095
Retentivity available	
 Retentivity available Retentivity preset Number of clock memories 	MB 0 to MB 15 8; 1 memory byte

Data blocks	
Retentivity adjustable	Yes; via non-retain property on DB
Retentivity adjustable Retentivity preset	Yes
Local data	
• per priority class, max.	32 768 byte; Max. 2048 bytes per block
Address area	
I/O address area	
• Inputs	8 192 byte
Outputs	8 192 byte
of which distributed	
— Inputs	8 192 byte
— Outputs	8 192 byte
Process image	
• Inputs	8 192 byte
 Outputs 	8 192 byte
 Inputs, adjustable 	8 192 byte
 Outputs, adjustable 	8 192 byte
• Inputs, default	1 024 byte
Outputs, default	1 024 byte
Subprocess images	
Number of subprocess images, max.	1
Digital channels	
• Inputs	65 536
— of which central	1 024
Outputs	65 536
— of which central	1 024
Analog channels	4,006
• Inputs	4 096
— of which central	256 4 096
Outputs — of which central	256
Hardware configuration	200
	2
Number of expansion units, max. Number of DP masters	3
• integrated	2
• via CP	4
Number of operable FMs and CPs (recommended)	,
FM	8
• CP, PtP	8
• CP, LAN	10
Rack	
• Racks, max.	4
Modules per rack, max.	8
Time of day	
Clock	
Hardware clock (real-time)	Yes
retentive and synchronizable	Yes
Backup time	6 wk; At 40 °C ambient temperature
Deviation per day, max.	10 s; Typ.: 2 s
Behavior of the clock following POWER-ON	Clock continues running after POWER OFF
 Behavior of the clock following expiry of backup 	the clock continues at the time of day it had when power was switched
period	off
Operating hours counter	
• Number	4
Number/Number range	0 to 3
Range of values	0 to 2^31 hours (when using SFC 101)
Granularity	1h
• retentive	Yes; Must be restarted at each restart
Clock synchronization	V
• supported	Yes

to MPI, master	Yes
• to MPI, slave	Yes
• to DP, master	Yes; With DP slave only slave clock
● to DP, slave	Yes
• in AS, master	Yes
• in AS, slave	Yes
on Ethernet via NTP	No
Digital inputs	
Number of digital inputs	0
Digital outputs	
Number of digital outputs	0
Analog inputs	
Number of analog inputs	0
Analog outputs	
Number of analog outputs	0
Interfaces	
Number of industrial Ethernet interfaces	0
Number of PROFINET interfaces	0
Number of RS 485 interfaces	2
Number of RS 422 interfaces	0
1. Interface	
Interface type	Integrated RS 485 interface
Isolated	Yes
Interface types	
• RS 485	Yes
Output current of the interface, max.	200 mA
Protocols	
• MPI	Yes
 PROFIBUS DP master 	Yes
 PROFIBUS DP slave 	Yes; A DP slave at both interfaces simultaneously is not possible
Point-to-point connection	No
MPI	
Transmission rate, max.	12 Mbit/s
Services	
— PG/OP communication	Yes
— Routing	Yes
 Global data communication 	Yes
 S7 basic communication 	Yes
— S7 communication	Yes; Only server, configured on one side
 S7 communication, as client 	No; but via CP and loadable FB
— S7 communication, as server	Yes
PROFIBUS DP master	40 Mb.Wa
Transmission rate, max. Number of DR slaves, max.	12 Mbit/s
Number of DP slaves, max. Sondard	124
Services	Von
— PG/OP communication	Yes Yes
— Routing	
Global data communication S7 basic communication	No Voc: I blocks only
— S7 basic communication — S7 communication	Yes; I blocks only Yes; Only server, configured on one side
	No
— S7 communication, as client	Yes
— S7 communication, as server	Yes
— Equidistance	
— Isochronous mode	No You
— SYNC/FREEZE	Yes
Activation/deactivation of DP slaves	Yes
 Number of DP slaves that can be simultaneously activated/deactivated, max. 	8
Direct data exchange (slave-to-slave)	Yes; as subscriber
communication)	

DD\/4	Vea
— DPV1	Yes
Address area	0 l/buto
— Inputs, max.	8 kbyte
— Outputs, max.	8 kbyte
User data per DP slave	244 byta
— Inputs, max.	244 byte
— Outputs, max.	244 byte
PROFIBUS DP slave	40 Mb 2/-
Transmission rate, max.	12 Mbit/s
automatic baud rate search	Yes; only with passive interface
Address area, max.	32 32 byte
User data per address area, max.	32 byte
Services — PG/OP communication	Vee
	Yes
— Routing	Yes; Only with active interface
— Global data communication	No No
— S7 basic communication	No
— S7 communication	Yes; Only server, configured on one side
— S7 communication, as client	No Vac Connection configured on one side only
— S7 communication, as server	Yes; Connection configured on one side only
 Direct data exchange (slave-to-slave communication) 	Yes
— DPV1	No
Transfer memory	
— Inputs	244 byte
— Outputs	244 byte
2. Interface	Z++ byte
	Integrated DS 495 interface
Interface type	Integrated RS 485 interface
Isolated	Yes
Interface types • RS 485	Yes
	200 mA
Output current of the interface, max. Protocols	200 IIIA
• MPI	No
PROFIBUS DP master	Yes
PROFIBUS DP slave	Yes; A DP slave at both interfaces simultaneously is not possible
	No
Point-to-point connection PROFIBUS DR moster	NO
PROFIBUS DP master • Transmission rate, max.	12 Mbit/s
•	124
Number of DP slaves, max. Services	124
— PG/OP communication	Voe
	Yes Yes
— Routing— Global data communication	ves No
— S7 basic communication	Yes; I blocks only
— S7 communication	Yes; Only server, configured on one side
— S7 communication, as client	No; but via CP and loadable FB
— S7 communication, as server	Yes
— Equidistance	Yes OR 64
— Isochronous mode	Yes; OB 61
— SYNC/FREEZE	Yes
Activation/deactivation of DP slaves	Yes
— Number of DP slaves that can be simultaneously activated/deactivated, max. Direct data exchange (along to playe).	8
Direct data exchange (slave-to-slave communication) PDV4	Yes; as subscriber
— DPV1	Yes
Address area	0.400.1
— Inputs, max.	8 192 byte
— Outputs, max.	8 192 byte
User data per DP slave	

— Inputs, max.	244 byte
— Outputs, max.	244 byte
PROFIBUS DP slave	2110,00
• GSD file	The latest GSD file is available on the Internet
	(http://www.siemens.com/profibus-gsd)
 Transmission rate, max. 	12 Mbit/s
 automatic baud rate search 	Yes; only with passive interface
 Address area, max. 	32
User data per address area, max.	32 byte
Services	
— PG/OP communication	Yes
— Routing	Yes; Only with active interface
 Global data communication 	No
 — S7 basic communication 	No
— S7 communication	Yes; Only server, configured on one side
 S7 communication, as client 	No; but via CP and loadable FB
 S7 communication, as server 	Yes
Direct data exchange (slave-to-slave communication)	Yes
communication) — DPV1	No
Transfer memory	
— Inputs	244 byte
— Outputs	244 byte
Protocols	, w
PROFIsafe	No
communication functions / header	INO
PG/OP communication	Yes
Data record routing	Yes
Global data communication	163
• supported	Yes
Number of GD loops, max.	8
Number of GD packets, max.	8
Number of GD packets, transmitter, max.	8
Number of GD packets, receiver, max.	8
Size of GD packets, max.	22 byte
Size of GD packet (of which consistent), max.	22 byte
S7 basic communication	22 5960
• supported	Yes
User data per job, max.	76 byte
User data per job (of which consistent), max.	76 byte; 76 bytes (with X_SEND or X_RCV); 64 bytes (with X_PUT or
o oder data per job (or willon deficiently, max.	X_GET as server)
S7 communication	
• supported	Yes
• as server	Yes
• as client	Yes; Via CP and loadable FB
 User data per job, max. 	See online help of STEP 7 (shared parameters of the SFBs/FBs and of
	the SFCs/FCs of S7 Communication)
S5 compatible communication	Vacción OD and landable FO
• supported	Yes; via CP and loadable FC
Number of connections	22
overall veable for PC communication	32
 usable for PG communication reserved for PG communication 	31
	1
— adjustable for PG communication, min.	1
— adjustable for PG communication, max.	31
usable for OP communication recorded for OP communication	31
— reserved for OP communication	1
— adjustable for OP communication, min.	1
— adjustable for OP communication, max.	31
usable for S7 basic communication recorded for S7 basic communication	30
reserved for S7 basic communication	0

 adjustable for S7 basic communication, min. 	0
 adjustable for S7 basic communication, max. 	30
usable for routing	X1 as a MPI, max. 10; X1 as DP Master max. 24; X1 as DP Slave
	(active) max. 14; X2 as DP Master max. 24; X2 as DP Slave (active) max. 14
S7 message functions	
Number of login stations for message functions, max.	32; Depending on the configured connections for PG/OP and S7 basic communication
Process diagnostic messages	Yes
simultaneously active Alarm-S blocks, max.	300
Test commissioning functions	
Status block	Yes; Up to 2 simultaneously
Single step	Yes
Number of breakpoints	4
Status/control	
 Status/control variable 	Yes
 Variables 	Inputs, outputs, memory bits, DB, times, counters
 Number of variables, max. 	30
— of which status variables, max.	30
— of which control variables, max.	14
Forcing	
Forcing	Yes
 Forcing, variables 	Inputs, outputs
Number of variables, max.	10
Diagnostic buffer	
present	Yes
 Number of entries, max. 	500
— adjustable	No
— of which powerfail-proof	100; Only the last 100 entries are retained
 Number of entries readable in RUN, max. 	499
— adjustable	Yes; From 10 to 499
— preset	10
Service data	
can be read out	Yes
A sould be set a sould be so a	
Ambient conditions	
Ambient temperature during operation	0.00
Ambient temperature during operation • min.	0 °C
Ambient temperature during operation • min. • max.	0 °C 60 °C
Ambient temperature during operation • min. • max. configuration / header	
Ambient temperature during operation • min. • max. configuration / header Configuration software	60 °C
Ambient temperature during operation • min. • max. configuration / header	
Ambient temperature during operation • min. • max. configuration / header Configuration software	60 °C Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite	60 °C Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7	60 °C Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC)	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB)	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL — SCL	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL — SCL — CFC	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes Yes
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL — SCL — CFC — GRAPH	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes Yes Yes Yes
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL — SCL — CFC — GRAPH — HiGraph®	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes Yes Yes Yes
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL — SCL — CFC — GRAPH — HiGraph® Know-how protection	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 • STEP 7 Lite configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language — LAD — FBD — STL — SCL — CFC — GRAPH — HiGraph® Know-how protection • User program protection/password protection	Yes; STEP 7 V5.5 + SP1 or higher or STEP 7 V5.3 + SP2 or higher with HSP 203 No see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye

Width	40 mm
Height	125 mm
Depth	130 mm
Weights	
Weight, approx.	360 g

last modified: 8/24/2021 🖸